



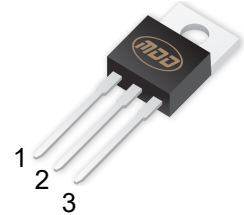
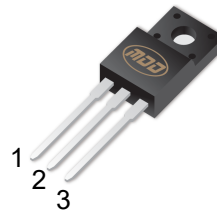
MDD10N65F/MDD10N65P

650V N-Channel Enhancement Mode MOSFET

V_{DS}	650 V
$I_D(T_c=25^\circ\text{C})$	10A
$R_{DS(on),max}$	1Ω@ $V_{GS}=10V$
$Q_{g,typ}$	34.2nC

TO-220F-3L

TO-220-3L



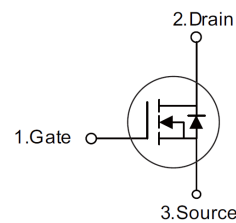
General Features

- Ultra low gate charge
- Low reverse transfer Capacitance
- Fast switching capability
- Avalanche energy tested
- Improved dv/dt capability, high ruggedness

Application

- High efficiency switch mode power supplies
- Electronic lamp ballasts based on half bridge
- LED power supplies

Equivalent Circuit



Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current	I_D	10	A
Pulsed Drain Current(Note 1)	I_{DM}	40	A
Avalanche Energy Single Pulsed (Note 2)	E_{AS}	500	mJ
Continuous diode forward current	I_S	10	A
Diode pulse current	$I_{S,pulse}$	40	A
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5	V/ns
Power Dissipation TO-220F	P_D	40	W
Power Dissipation TO-220		130	W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{stg}	-55 ~ 150	°C

Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO-220F	TO-220	
Thermal resistance, Junction-to-case	$R_{\theta JC}$	3.13	0.96	°C/W
Thermal resistance, Junction-to-ambient	$R_{\theta JA}$	110	62.5	°C/W

- Notes:**
1. Pulse width limited by maximum junction temperature.
 2. L=10mH, $I_{AS} = 10A$, Starting $T_J = 25^\circ\text{C}$.
 3. $I_{SD} = 10A$, $di/dt \leq 100A/\mu s$, $V_{DD} \leq BV_{DS}$, Starting $T_J = 25^\circ\text{C}$.



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Ta = 25°C unless otherwise specified

Symbol	Parameter	Condition	Min	Typ	Max	Unit	
V_{(BR)DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	650	--	--	V	
I_{GSS}	Gate-Source Leakage Current	Forward	V_{GS}=30V, V_{DS}=0V	--	--	100	nA
		Reverse	V_{GS}=-30V, V_{DS}=0V	--	--	-100	nA
I_{DSS}	Drain-Source Leakage Current	V_{DS}=650V, V_{GS}=0V	--	--	1	uA	
V_{GS(TH)}	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	2.0	--	4.0	V	
R_{DS(ON)}	Drain-Source On-State Resistance	V_{GS}=10V, I_D=5A	--	0.81	1.0	Ω	

Dynamic Electrical Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	V_{DS}=25V V_{GS}=0V f=1MHz	--	1622		pF
C_{oss}	Output Capacitance		--	144.2		pF
C_{rss}	Reverse Transfer Capacitance		--	6.8		pF
Q_g	Total Gate Charge	V_{DS}=520V, V_{GS}=10V, I_D=10A (Note1,2)	--	34.2	--	nC
Q_{gs}	Gate Source Charge		--	8.8	--	nC
Q_{gd}	Gate Drain Charge		--	12.89	--	nC

Switching Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
t_{d(on)}	Turn on Delay Time	V_{DS}=325V, I_D=10A, R_G=10Ω (Note1,2)	--	--	14.16	ns
t_r	Turn on Rise Time		--	--	34.64	ns
t_{d(off)}	Turn Off Delay Time		--	--	65.72	ns
t_f	Turn Off Fall Time		--	--	16.04	ns

Source Drain Diode Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
I_{SD}	Source drain current(Body Diode)		--	--	10	A
I_{SM}	Pulsed Current		--	--	40	A
V_{SD}	Drain-Source Diode Forward Voltage	I_S=10A, V_{GS}=0V	--	--	1.5	V
t_{rr}	Body Diode Reverse Recovery Time	V_R=325 I_F=10A, -dI_F/dt =100A/μs	--	418.8	--	ns
Q_{rr}	Body Diode Reverse Recovery Charge		--	3.40	--	uC

Notes:

- 1.Pulse test ; Pulse width≤300us, duty cycles≤2%.
- 2.Essentially independent of operating temperature.



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Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

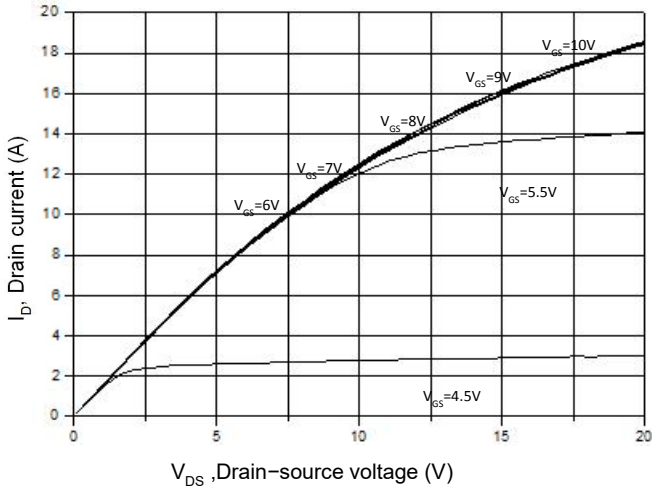


Figure 2. Transfer Characteristics

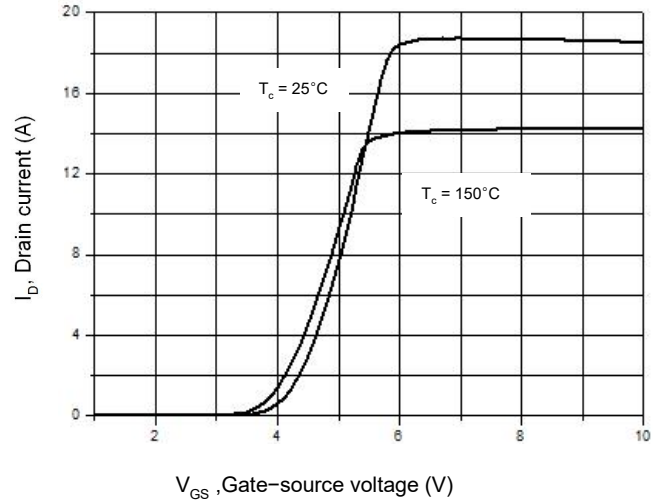


Figure 3. On-Resistance Variation vs. Drain Current

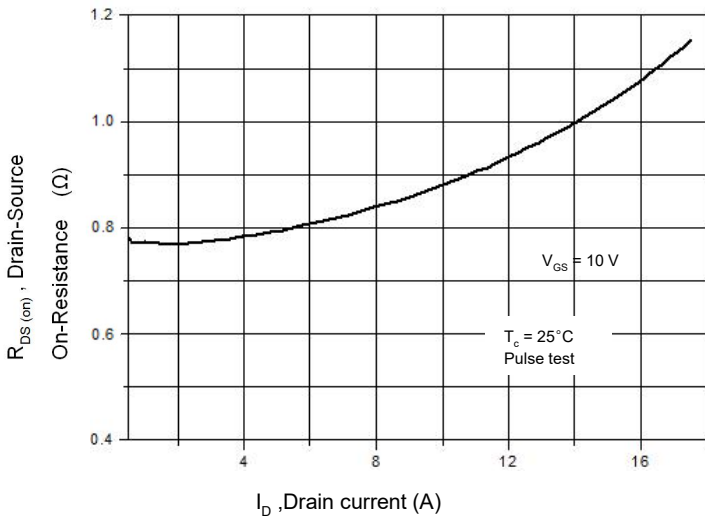


Figure 4. Threshold Voltage vs. Temperature

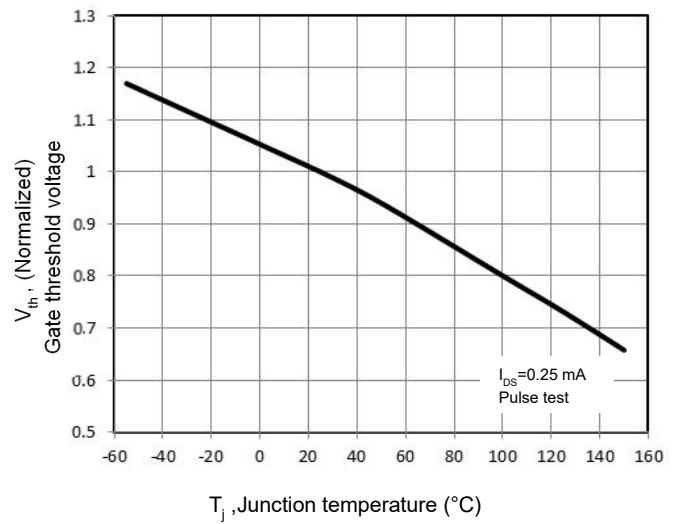


Figure 5. Breakdown Voltage vs. Temperature

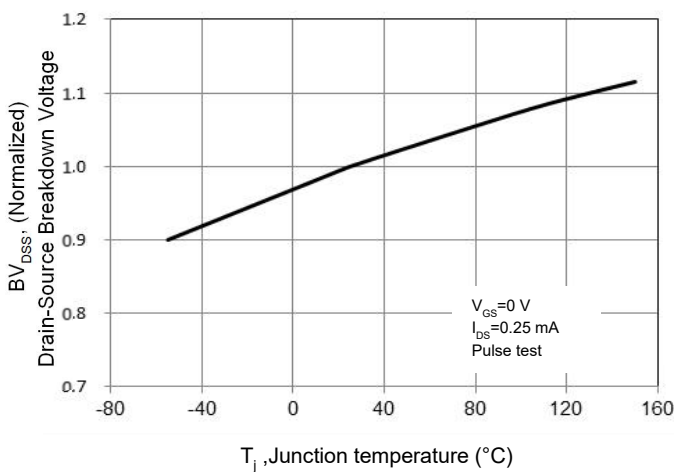
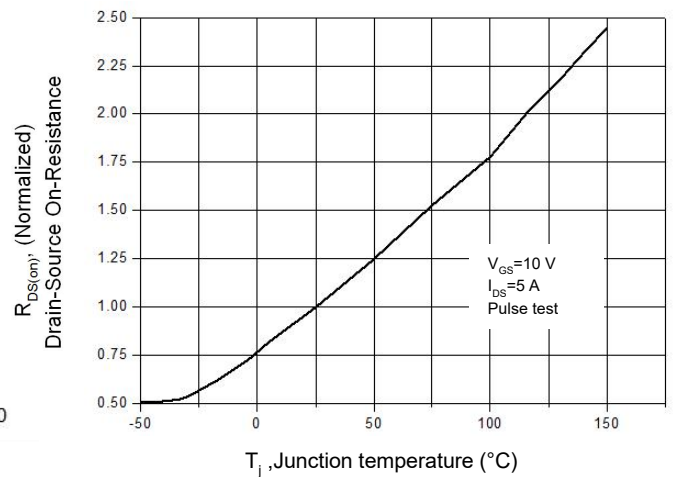


Figure 6. On-Resistance vs. Temperature





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Figure 7. Capacitance Characteristics

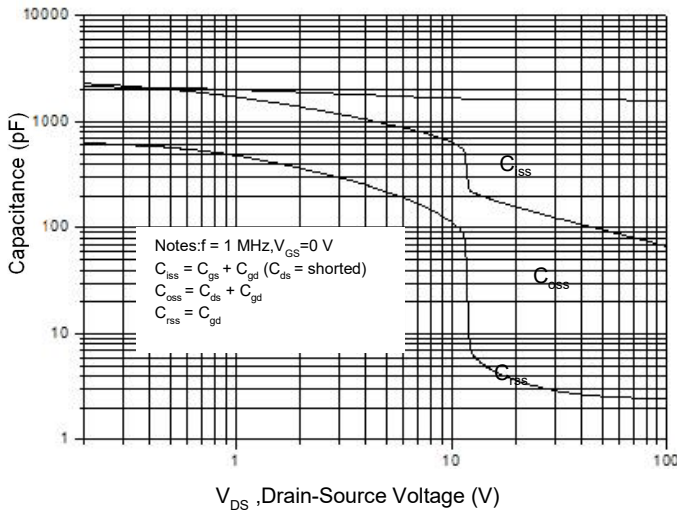


Figure 8. Gate Charge Characteristics

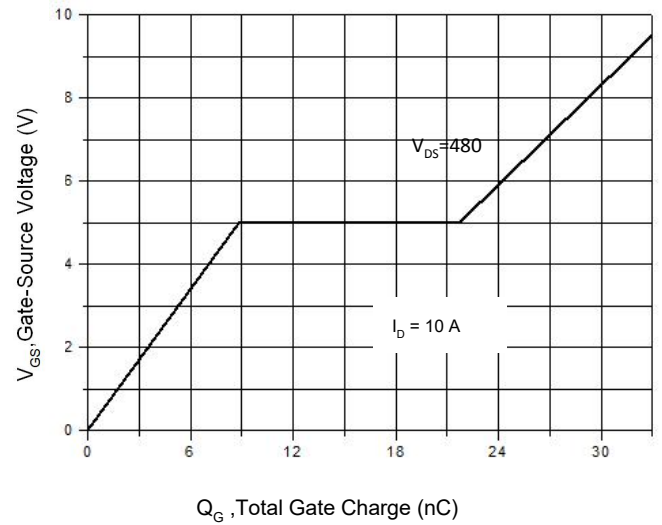


Figure 9. Maximum Safe Operating Area TO-220F

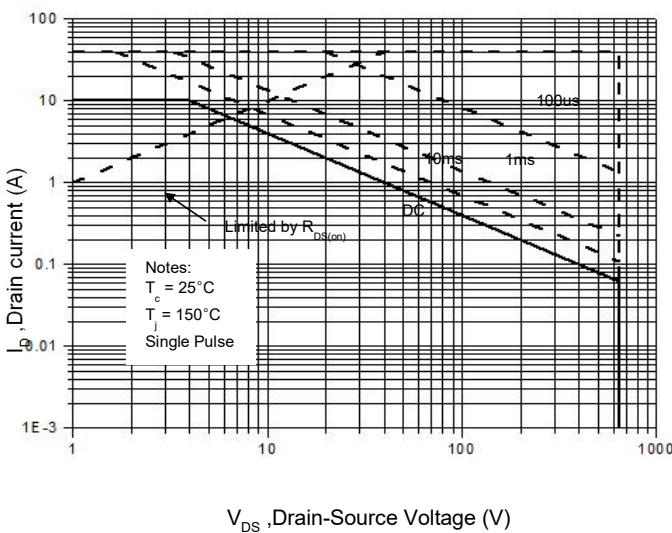


Figure 10. Maximum Safe Operating Area TO-220

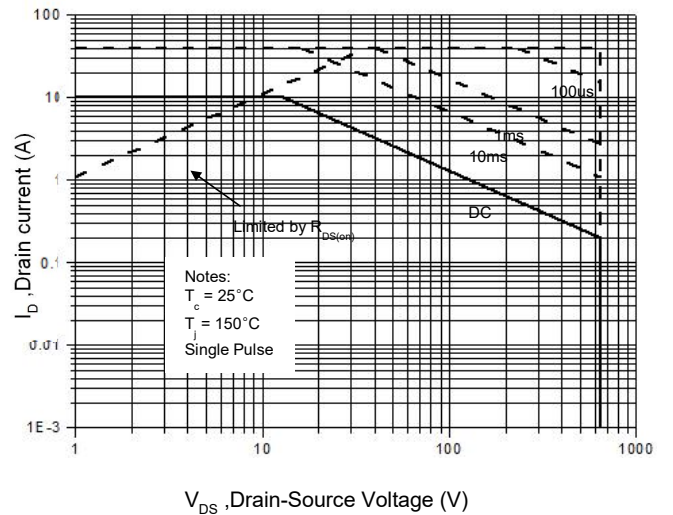


Figure 11. Power Dissipation vs. Temperature TO-220F

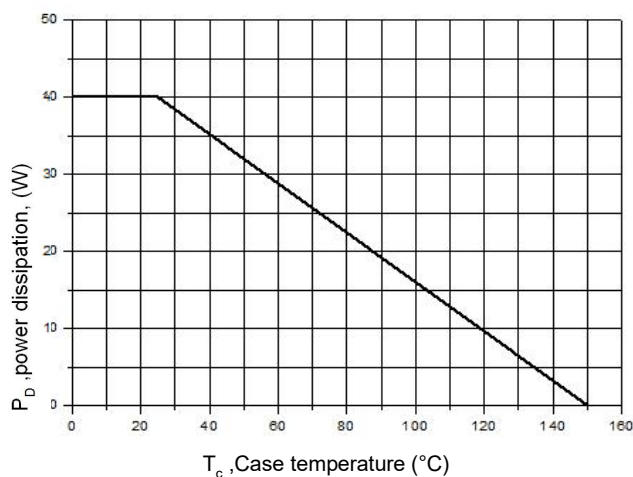
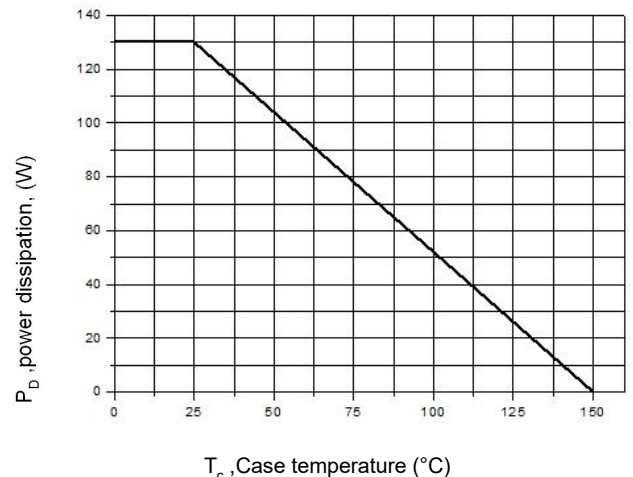


Figure 12. Power Dissipation vs. Temperature TO-220





MDD10N65F/MDD10N65P

650V N-Channel Enhancement Mode MOSFET

Figure 13. Continuous Drain Current vs. Temperature

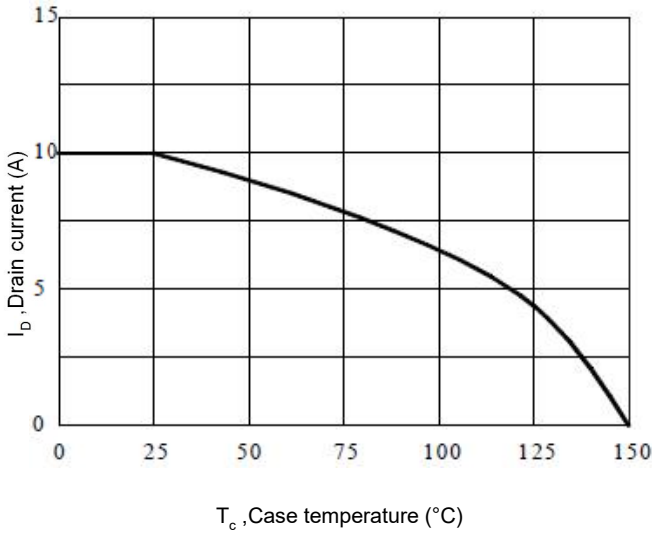


Figure 14. Body Diode Transfer Characteristics

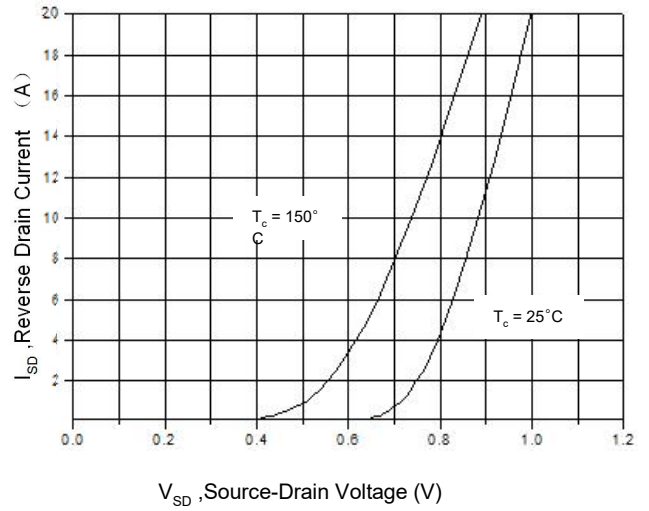


Figure 15 Transient Thermal Impedance, Junction to Case, TO-220F

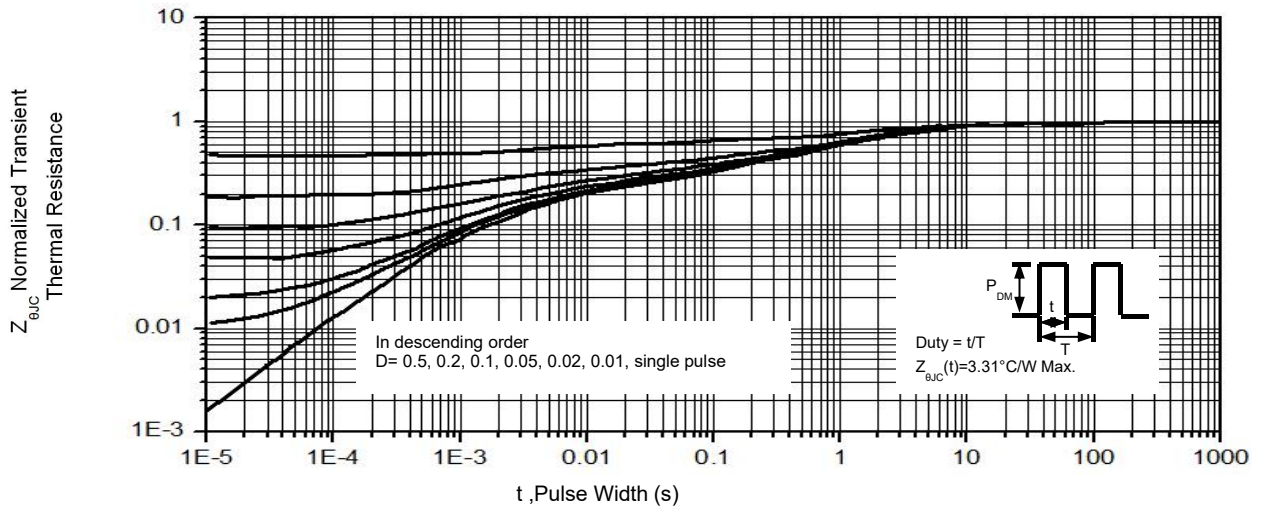
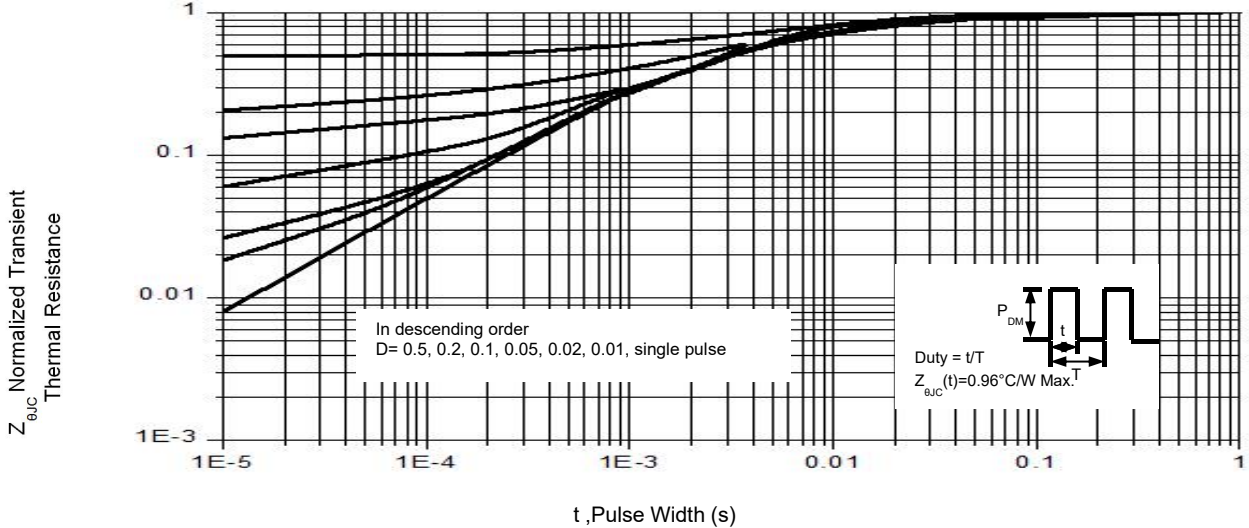


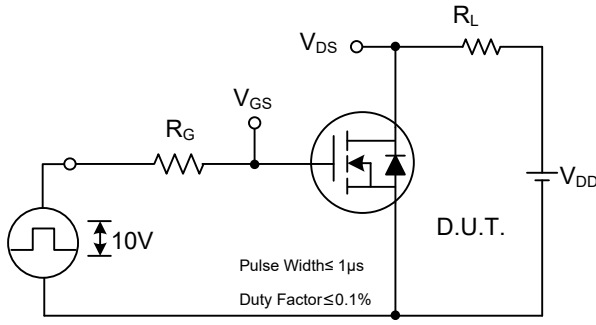
Figure 16. Transient Thermal Impedance, Junction to Case, TO-220



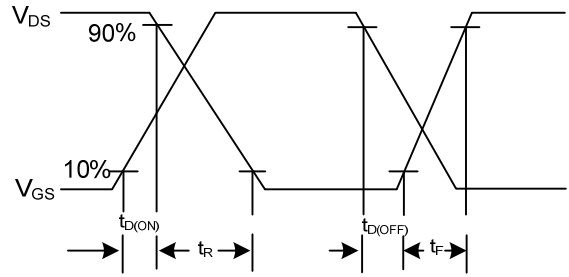


MDD10N65F/MDD10N65P

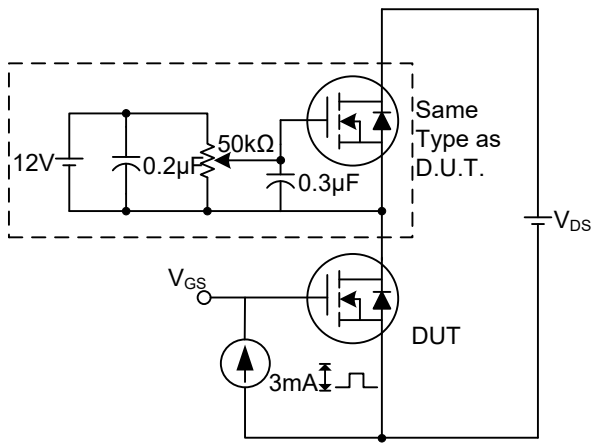
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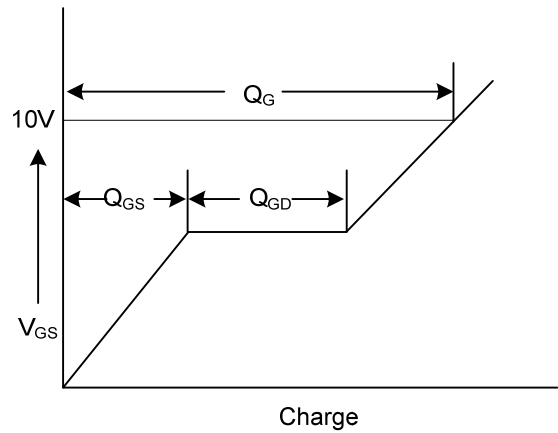
Switching Test Circuit



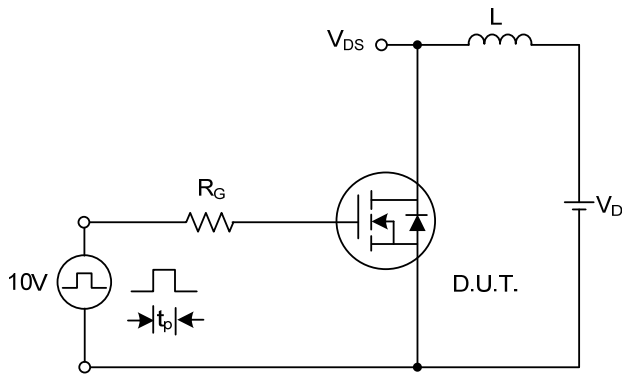
Switching Waveforms



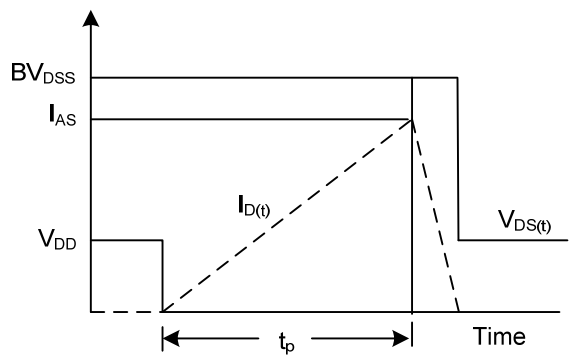
Gate Charge Test Circuit



Gate Charge Waveform



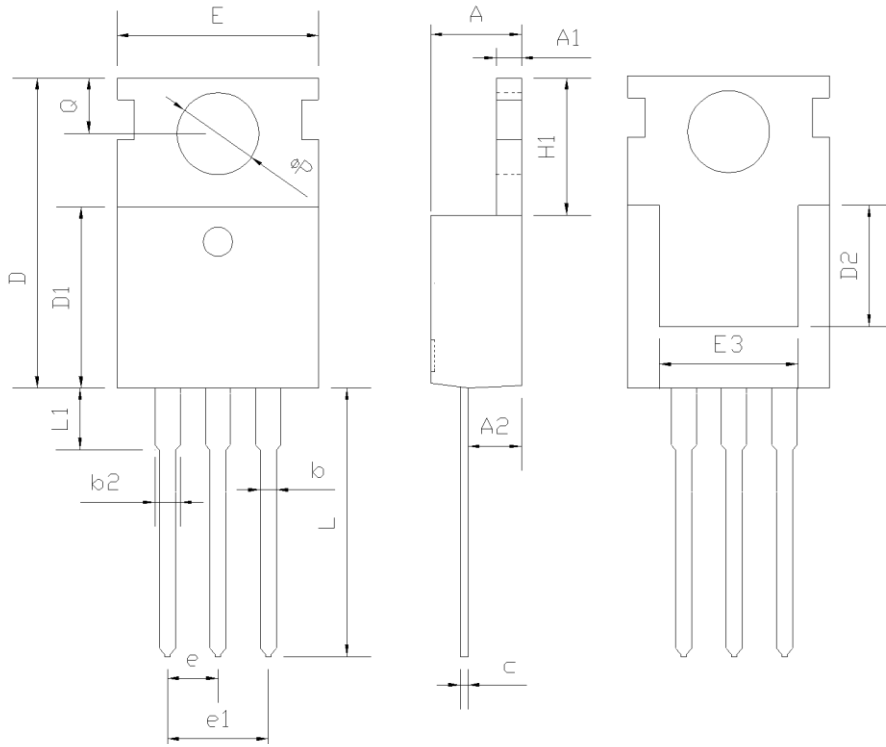
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

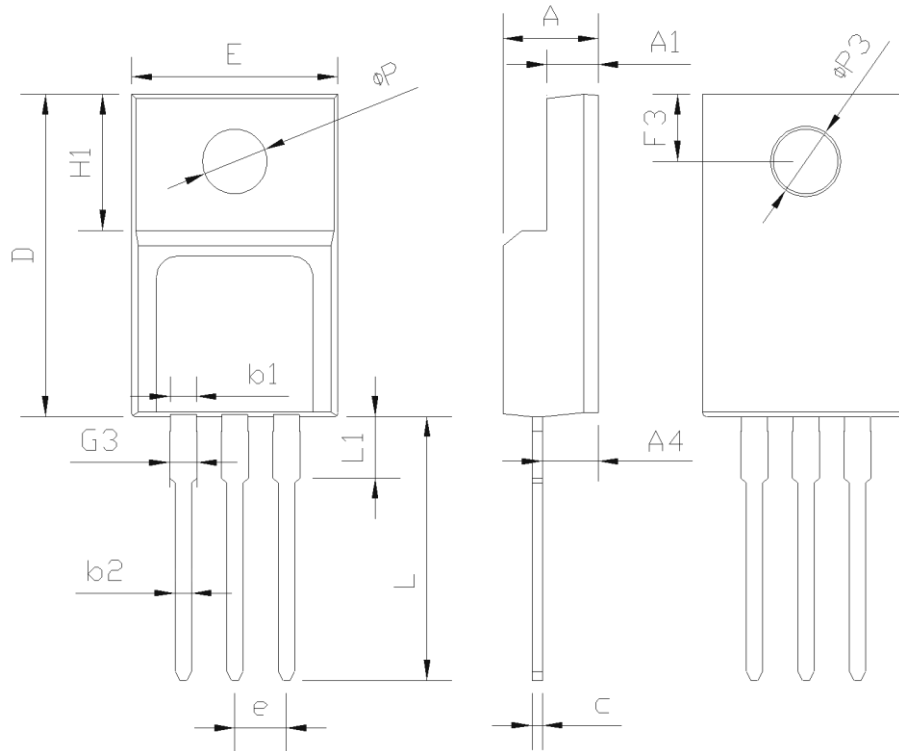
The curve above is for reference only.

Mechanical Dimensions for TO-220-3L



SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.45	0.50	0.60
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ΦP	3.40	3.60	3.80
Q	2.60	2.80	3.00

Mechanical Dimensions for TO-220F-3L



SYMBOL	mm		
	MIN	NOM	MAX
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
D	15.57	15.87	16.17
H1	6.70REF		
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95

Package Marking and Ordering Information

Part Number	Marking	Package	Units/Tube	Units/Reel
MDD10N65F	10N65F	TO-220F	50	
MDD10N65P	10N65P	TO-220-3L	50	

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